TOSHIBA Photocoupler Photorelay

# TLP592G

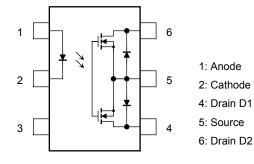
### Telecommunications PBX Modems

The Toshiba TLP592G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a six lead plastic DIP package (DIP6).

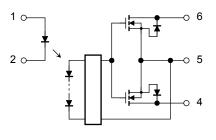
The TLP592G is a bi-directional switch can replace mechanical relays in many applications.

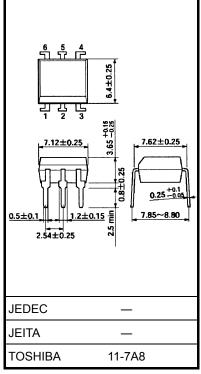
- 6-pin DIP (DIP6)
- 1-Form-A
- Peak Off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 110 mA (max)
- On-state resistance:  $35 \Omega$  (max, t < 1 s)
- On-state resistance: 50  $\Omega$  (max, continuous)
- Isolation voltage: 2500 Vrms (min)

#### Pin Configuration (top view)



### Schematic





Weight: 0.4 g (typ.)

#### Absolute Ratings (Ta = 25°C)

|   | Characteristics                            |              | Symbol               | Rating  | Unit  |
|---|--|--------------|----------------------|---------|-------|
| LED   | Forward current                            |              | ١ <sub>F</sub>       | 50      | mA    |
|   | Forward current derati<br>(Ta≧25°C)        | ing          | ∆I <sub>F</sub> /°C  | -0.5    | mA/°C |
|   | Peak forward current (100 μs pulse, 100 pp | s)           | IFP                  | 1       | А     |
|   | Reverse voltage                            |              | V <sub>R</sub>       | 5       | V     |
|   | Junction temperature                       |              | Тj                   | 125     | °C    |
|   | Off-state output termin                    | nal voltage  | VOFF                 | 350     | V     |
|   | On-state current                           | A connection |                      | 120     |       |
|   |  | B connection | I <sub>ON</sub>      | 120     | mA    |
|   |  | C connection |                      | 240     |       |
| Detector  | On-state current<br>derating (Ta ≧ 25°C)   | A connection |                      | -1.2    |       |
|   |  | B connection | ∆l <sub>ON</sub> /°C | -1.2    | mA/°C |
|   |  | C connection |                      | -2.4    |       |
|   | Junction temperature                       |              | Tj                   | 125     | °C    |
| Storage temperature range                               |  |              | T <sub>stg</sub>     | -55~125 | °C    |
| Operating temperature range                             |  |              | T <sub>opr</sub>     | -40~85  | °C    |
| Lead soldering temperature (10 s)                       |  |              | T <sub>sol</sub>     | 260     | °C    |
| Isolation voltage (AC, 1 min, R.H. $\leq$ 60%) (Note 1) |  |              | BVS                  | 2500    | Vrms  |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

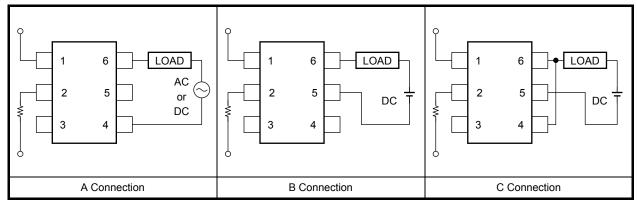
Note 1: Device considered a two-terminal device: LED side pins shorted together, and detector side pins shorted together.

#### **Recommended Operating Conditions**

| Characteristics       | Symbol           | Min | Тур. | Max | Unit |
|-----------------------|------------------|-----|------|-----|------|
| Supply voltage        | V <sub>DD</sub>  | —   | —    | 280 | V    |
| Forward current       | ١ <sub>F</sub>   | 5   | 7.5  | 25  | mA   |
| On-state current      | I <sub>ON</sub>  | _   | _    | 100 | mA   |
| Operating temperature | T <sub>opr</sub> | -20 | _    | 65  | °C   |

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### **Circuit Connections**



## Individual Electrical Characteristics (Ta = 25°C)

| Characteristics |                   | Symbol           | Test Condition           | Min | Тур. | Max | Unit |
|-----------------|-------------------|------------------|--------------------------|-----|------|-----|------|
|                 | Forward voltage   | VF               | I <sub>F</sub> = 10 mA   | 1.0 | 1.15 | 1.3 | V    |
| LED             | Reverse current   | I <sub>R</sub>   | $V_R = 5 V$              | _   | _    | 10  | μA   |
|                 | Capacitance       | CT               | V = 0, f = 1 MHz         |     | 30   | _   | pF   |
| Detector        | Off-state current | IOFF             | V <sub>OFF</sub> = 350 V |     | _    | 1   | μA   |
| Delector        | Capacitance       | C <sub>OFF</sub> | V = 0, f = 1 MHz         | _   | 30   |     | pF   |

### **Coupled Electrical Characteristics (Ta = 25°C)**

| Characteristics        |              | Symbol          | Test Condition   | Min | Тур. | Max | Unit |
|------------------------|--------------|-----------------|--|-----|------|-----|------|
| Trigger LED current    |              | I <sub>FT</sub> | I <sub>ON</sub> = 120 mA                                 |     | 1    | 3   | mA   |
| Return LED current     |              | I <sub>FC</sub> | I <sub>OFF</sub> = 100 μA                                | 0.1 | _    | _   | mA   |
| On-state<br>resistance | A connection | R <sub>ON</sub> | I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA, t < 1 s |     | 25   | 35  |      |
|                        | A connection |                 | I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA          |     | 35   | 50  | 0    |
|                        | B connection |                 | I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA          |     | 28   | 40  | Ω    |
|                        | C connection |                 | I <sub>ON</sub> = 240 mA, I <sub>F</sub> = 5 mA          | —   | 14   | 20  |      |

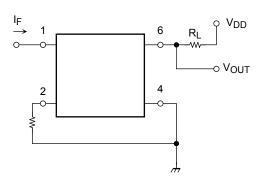
#### **Isolation Characteristics (Ta = 25°C)**

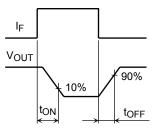
| Characteristics             | Symbol         | Test Condition                                 | Min               | Тур.             | Max | Unit   |
|-----------------------------|----------------|--|-------------------|------------------|-----|--------|
| Capacitance input to output | CS             | $V_{S} = 0 V, f = 1 MHz$                       | —                 | 0.8              | _   | pF     |
| Isolation resistance        | R <sub>S</sub> | $V_{S} = 500 \text{ V}, \text{ R.H.} \le 60\%$ | $5 	imes 10^{10}$ | 10 <sup>14</sup> | _   | Ω      |
|                             |                | AC, 1 min                                      | 2500              | _                | _   | Vrms   |
| Isolation voltage           |                | AC, 1 s, in oil                                | —                 | 5000             | _   | VIIIIS |
|                             |                | DC, 1 min, in oil                              | —                 | 5000             | _   | Vdc    |

### Switching Characteristics (Ta = 25°C)

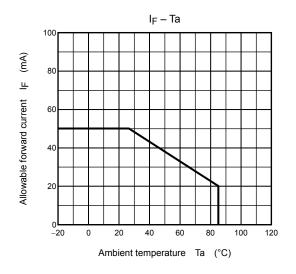
| Characteristics | Symbol          | Test Condition  | Min | Тур. | Max | Unit |
|-----------------|-----------------|---|-----|------|-----|------|
| Turn-on time    | t <sub>ON</sub> | R <sub>L</sub> = 200 Ω  |     | 0.3  | 1   | me   |
| Turn-off time   | tOFF            | $V_{DD} = 20 \text{ V}, \text{ I}_{\text{F}} = 5 \text{ mA}$ (Note 2) |     | 0.1  | 1   | ms   |

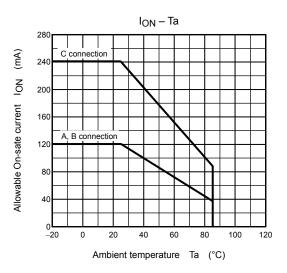
Note 2: Switching time test circuit

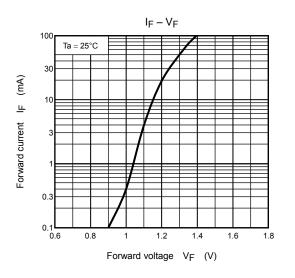


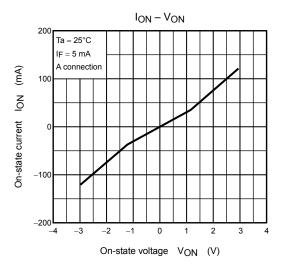


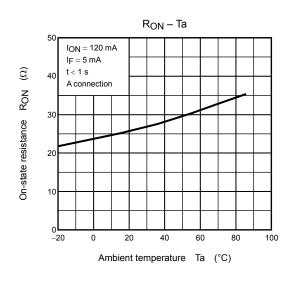
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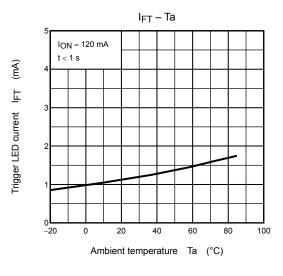




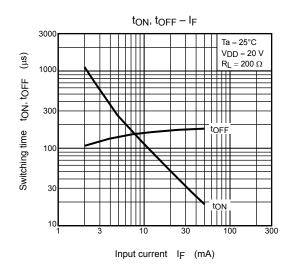


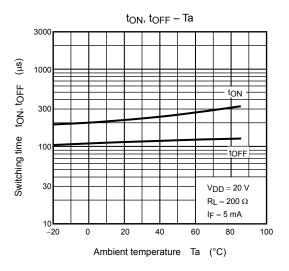


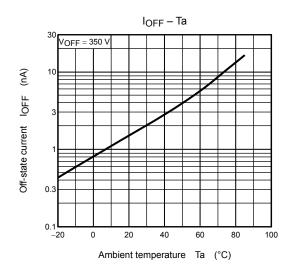




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